



APPLICATIONS

- SONET OC-3/SDH STM-1 Receiver
- FDDI, Ethernet Fiber LAN
- Low Noise RF Amplifier

FEATURES

- **Single +5 Volt Supply**
- **Automatic Gain Control**
- **Excellent Sensitivity (- 41dBm)**
- **0 dBm Optical Overload**

ELECTRICAL CHARACTERISTICS: (1) ($T_A = 25^\circ\text{C}$, $V_{DD} = +5.0\text{V} \pm 10\%$, $C_{DIODE} + C_{STRAY} = 0.5\text{ pF}$, Det. cathode to I_{IN})

| PARAMETER | MIN | TYP | MAX | UNIT |
|---|-------|-------|-------|----------------------------|
| Transresistance($R_L = \square, I_{DC} < 500\text{nA}$) | 20 | 30 | | $\text{K}\square$ |
| Transresistance ($R_L = 50\square$) ⁽¹⁾ | 9.5 | 13 | | $\text{K}\square$ |
| Bandwidth -3dB | 110 | 120 | | MHz |
| Input Resistance ⁽²⁾ | | 1000 | | \square |
| Output Resistance | 30 | 50 | 60 | \square |
| Supply Current | | 30 | 45 | mA |
| Input Offset Voltage | 1.1 | 1.4 | | Volts |
| Output Offset Voltage | | 1.4 | | Volts |
| AGC Threshold (I_{IN}) ⁽³⁾ | | 15 | | μA |
| Optical Overload ⁽⁴⁾ | 0 | + 1 | | dBm |
| Input Noise Current ⁽⁵⁾ | | 12 | | nA |
| AGC Time Constant ⁽⁶⁾ | | 16 | | $\square\text{sec}$ |
| Offset Voltage Drift | | 1 | | $\text{mV}/^\circ\text{C}$ |
| Optical Sensitivity ⁽⁷⁾ | | - 41 | | dBm |
| Operating Voltage Range | + 4.5 | + 5.0 | + 6.0 | Volts |
| Operating Temperature Range | - 40 | | 85 | $^\circ\text{C}$ |
| Thermal Resistance | | 20 | | $^\circ\text{C}/\text{W}$ |

1. $f = 50\text{MHz}$
2. Measured with I_{IN} below AGC Threshold. During AGC, input impedance will decrease proportionally to I_{IN} .
3. Defined as the I_{IN} where Transresistance has decreased by 50%.
4. See note on "Indirect Measurement of Optical Overload".
5. See note on "Measurement of Input Referred Noise Current".
6. $C_{AGC} = 220\text{ pF}$
7. Parameter is guaranteed (not tested) by design and characterization data @ 155 Mb/s, assuming detector responsivity of 0.95.

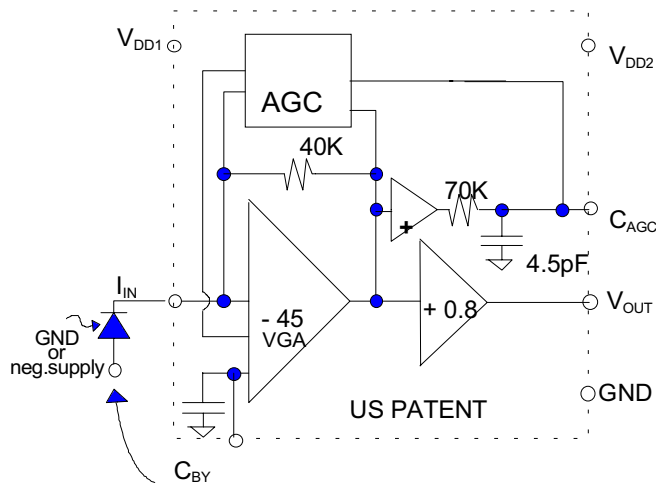
ABSOLUTE MAXIMUM RATINGS

| | |
|-----------|-----------------------------------|
| V_{DD1} | 7.0 V |
| V_{DD2} | 7.0 V |
| I_{IN} | 5 mA |
| T_A | Operating Temp. - 40° C to 125° C |
| T_S | Storage Temp. - 65° C to 150° C |

ATA01502D1C PAD DESCRIPTION

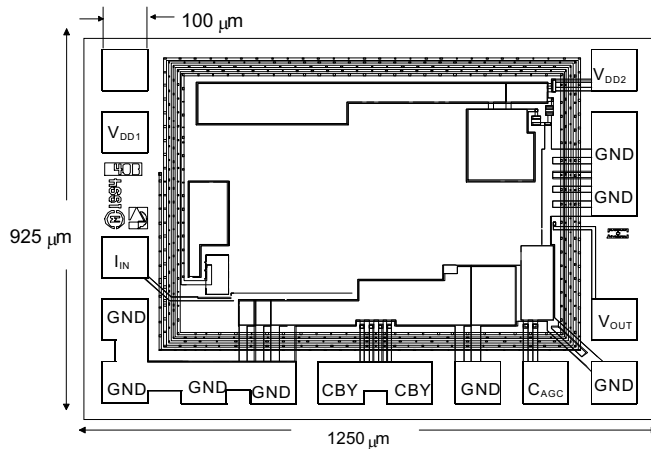
| PAD | Description | Comment |
|-----------|-----------------------------------|---|
| V_{DD1} | V_{DD1} | Positive supply for input gain stage |
| V_{DD2} | V_{DD2} | Positive supply for second gain stage |
| I_{IN} | TIA Input Current | Connect detector cathode for proper operation |
| V_{OUT} | TIA Output Voltage | Requires external DC block |
| C_{AGC} | External AGC Capacitor | $70K * (4.5p + C_{AGC}) = \text{AGC Time Constant}$ |
| C_{RY} | Input Gain Stage Bypass Capacitor | >56 pF |

ATA01502D1C EQUIVALENT CIRCUIT

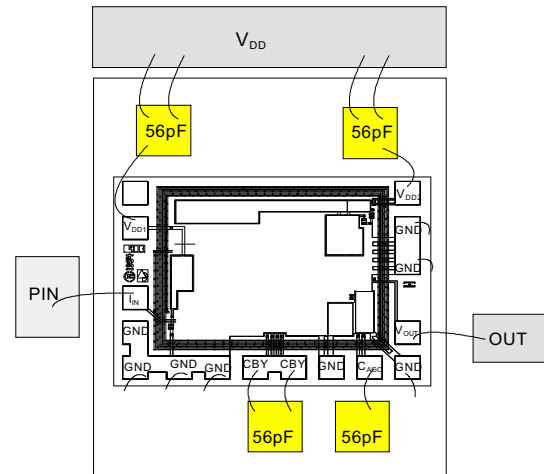


Photodiode cathode must be connected to I_{IN} for proper AGC operation

ATA01502 BONDING PADS



TYPICAL BONDING DIAGRAM

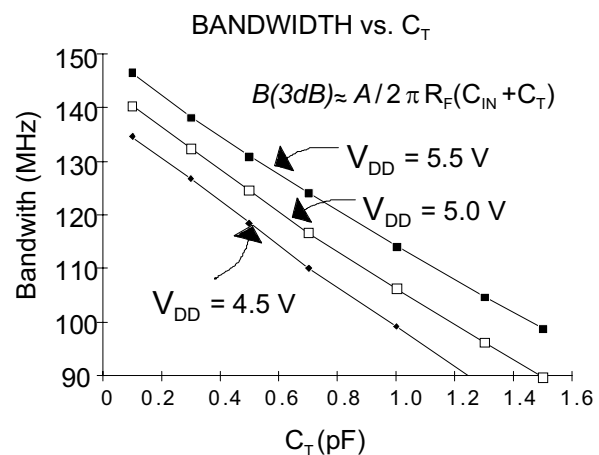
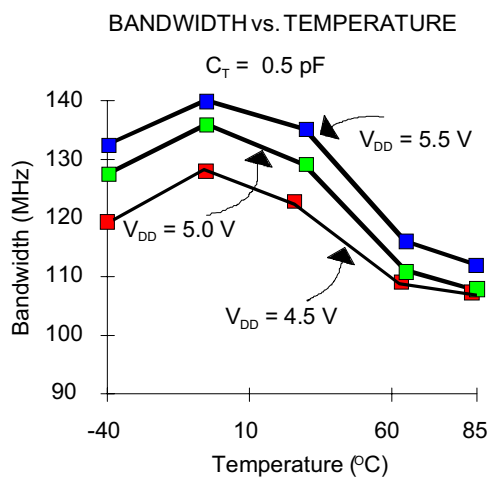


POWER SUPPLIES AND GENERAL LAYOUT CONSIDERATIONS

The ATA01502D1C may be operated from a positive supply as low as + 4.5 V and as high as + 6.0 V. Below + 4.5 V, bandwidth, overload and sensitivity will degrade, while at + 6.0 V, bandwidth, overload and sensitivity improve (see "Bandwidth vs. Temperature" curves). Use of surface mount (preferably MIM type capacitors), low inductance power supply bypass capacitors ($\geq 56\text{pF}$) are essential for good high frequency and low noise performance. The power supply bypass capacitors should be mounted on or connected to a good low inductance ground plane.

GENERAL LAYOUT CONSIDERATIONS

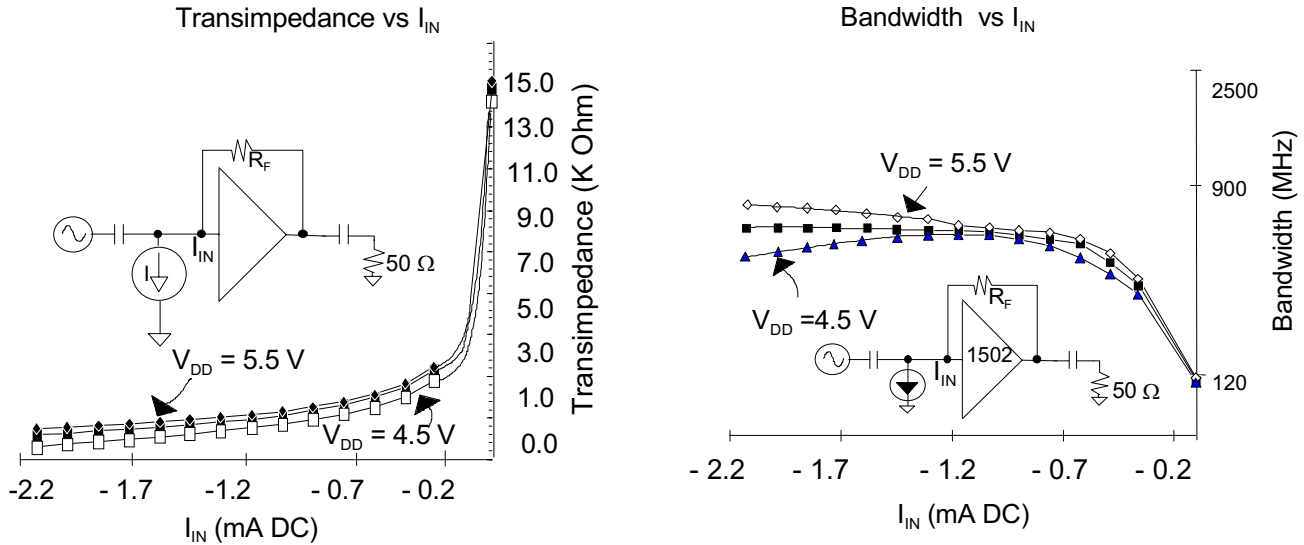
Since the gain stages of the transimpedance amplifier have an open loop bandwidth in excess of 1.0 GHz, it is essential to maintain good high frequency layout practices. To prevent oscillations, a low inductance RF ground plane should be made available for power supply bypassing. Traces that can be made short should be made short. The utmost care should be taken to maintain very low capacitance at the photodiode TIA interface (I_{IN}), as excess capacitance at this node will cause a degradation in bandwidth and sensitivity (see Bandwidth vs. C_T curves).



Note: All performance curves are typical @ $T_A = 25^\circ \text{C}$ unless otherwise note.

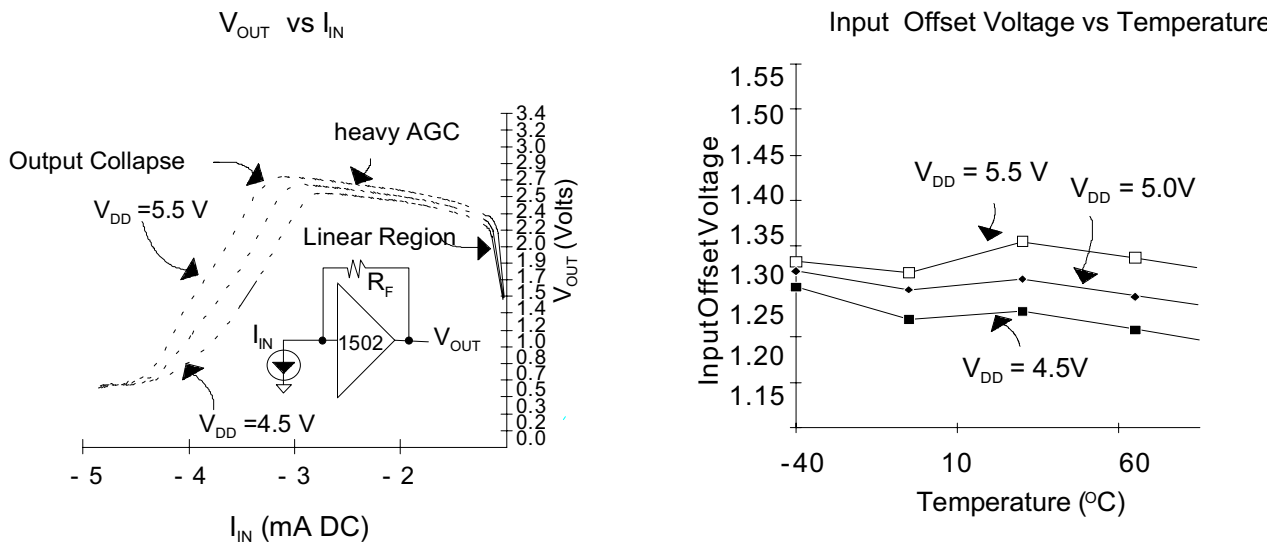
I_{IN} CONNECTION

(Refer to the equivalent circuit diagram) Bonding the detector cathode to I_{IN} (and thus drawing current from the ATA01502D1C) improves the dynamic range. The detector may be used in the reverse direction for input currents not exceeding 13 μ A, however the specifications for optical overload will not be met.



V_{OUT} CONNECTION

The output pad should be connected via a coupling capacitor to the next stage of the receiver channel (filter or decision circuits), as the output buffers are not designed to drive a DC coupled 50 ohm load (this would require an output bias current of approximately 36 mA to maintain a quiescent 1.8 Volts across the output load). If V_{OUT} is connected to a high input impedance decision circuit (>500 ohms), then a coupling capacitor may not be required, although caution should be exercised since DC offsets of the photo detector/TIA combination may cause clipping of subsequent gain or decision circuits.



C_{BY} CONNECTION

The C_{BY} pad must be connected via a low inductance path to a surface mount capacitor of at least 56pF (additional capacitance can be added in parallel with the 56 pF or 220 pF capacitors to improve low frequency response and noise performance). Referring to the equivalent circuit diagram and the typical bonding diagram, it is critical that the connection from C_{BY} to the bypass capacitor use two bond wires for low inductance, since any high frequency impedance at this node will be fed back to the open loop amplifier with a resulting loss of transimpedance bandwidth. Two pads are provided for this purpose.

SENSITIVITY AND BANDWIDTH

In order to guarantee sensitivity and bandwidth performance, the TIA is subjected to a comprehensive series of tests at the die sort level (100% testing at 25 °C) to verify the DC parametric performance and the high frequency performance (i.e. adequate |S₂₁|) of the amplifier. Acceptably high |S₂₁| of the internal gain stages will ensure low amplifier input capacitance and hence low input referred noise current. Transimpedance sensitivity and bandwidth are then guaranteed by design and correlation with RF and DC die sort test results. In applications that require - 41 dBm sensitivity, a low capacitance (< 0.5pF) and high responsivity (> 0.95) photodiode must be used.

INDIRECT MEASUREMENT OF OPTICAL OVERLOAD

Optical overload can be defined as the maximum optical power above, which the BER (bit error rate) increases beyond 1 error in 10¹⁰ bits. The ATA01502D1C is 100% tested at die sort by a DC measurement, which has excellent correlation with a PRBS optical overload measurement. The measurement consists of sinking a negative current (see V_{OUT} Vs I_{IN} figure) from the TIA and determining the point of output voltage collapse. In addition, the input node virtual ground during "heavy AGC" is checked to verify that the linearity (i.e. pulse width distortion) of the amplifier has not been compromised. As a final test, a DC transfer curve is performed on every die at the wafer level to ensure excellent overload performance.

MEASUREMENT OF INPUT REFERRED NOISE CURRENT

The "Input Noise Current" is directly related to sensitivity. It can be defined as the output noise voltage (V_{OUT}), with no input signal, (including a 100 MHz lowpass filter at the output of the TIA) divided by the AC transresistance.

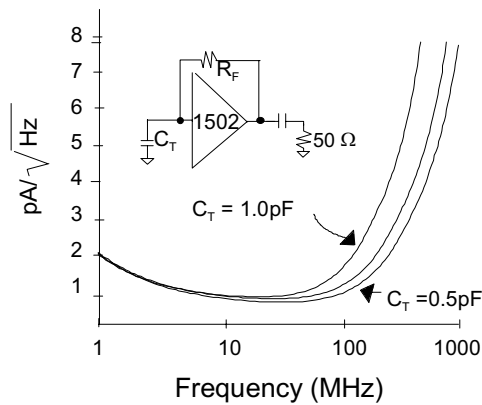
AGC CAPACITOR

It is important to select an external AGC capacitor of high quality and appropriate size. The ATA01502D1C has an on-chip 70 K \square resistor with a shunt 4.5-pF capacitor to ground. Without external capacitance, the chip will provide an AGC time constant of 315 nS. For the best performance in a typical 155MB/s SONET receiver, a minimum AGC capacitor of 56pF is recommended. This will provide the minimum amount of protection against pattern sensitivity and pulse width distortion on repetitive data sequences during high average optical power conditions. Conservative design practices should be followed when selecting an AGC capacitor, since unit to unit variability of the internal time constant and various data conditions can lead to data errors if the chosen value is too small.

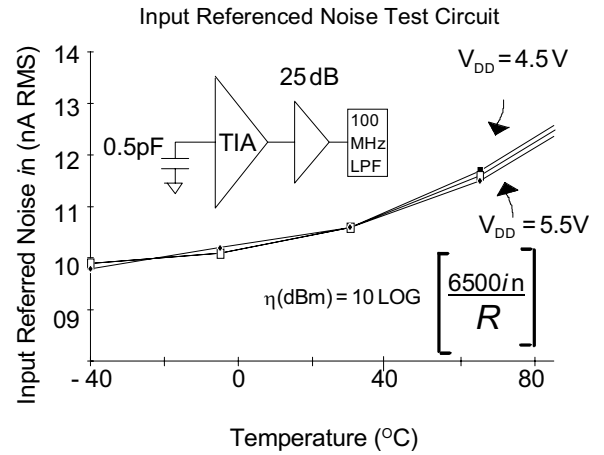
PHASE RESPONSE

At frequencies below the 3dB bandwidth of the device, the transimpedance phase response is characteristic of a single pole transfer function (as shown in the Phase Vs Frequency curve). The output impedance is essentially resistive up to 1000 MHz.

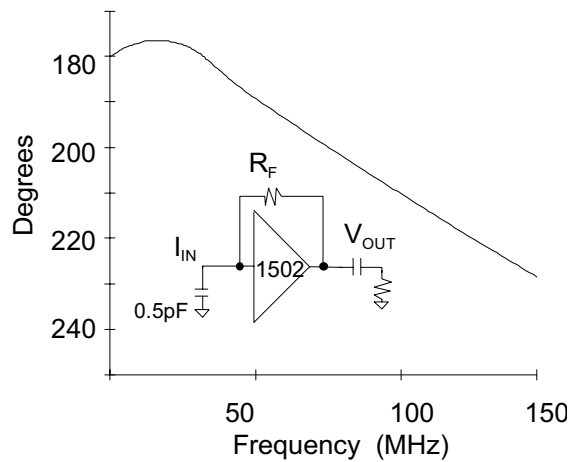
Input Referred Noise Spectral Density vs Frequency



INPUT REFERRED NOISE vs. TEMPERATURE



Phase (I_{IN} to V_{OUT})



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